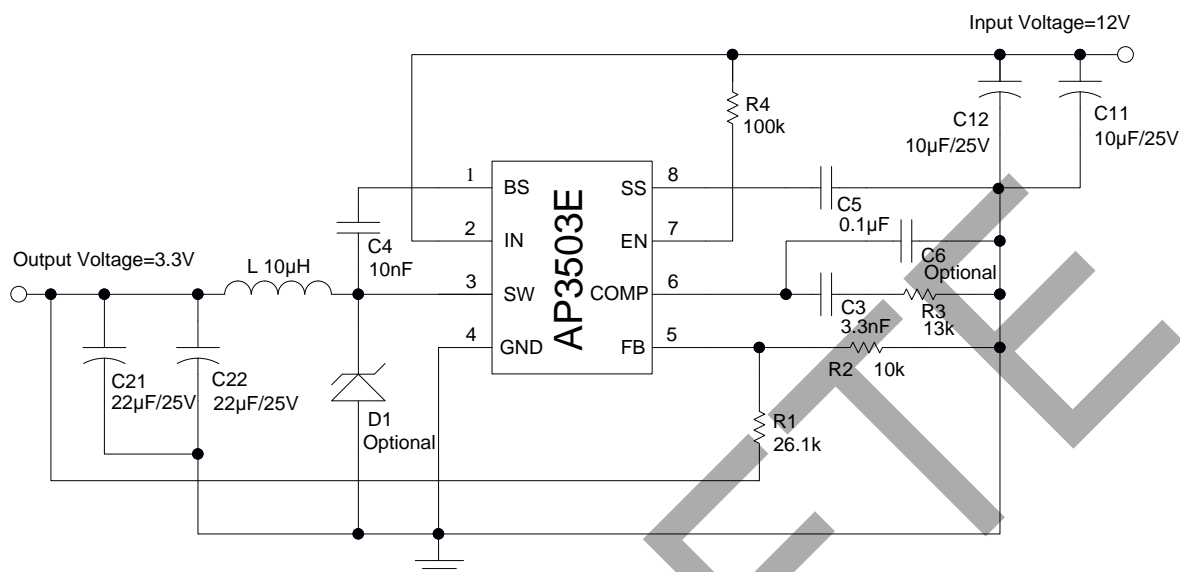


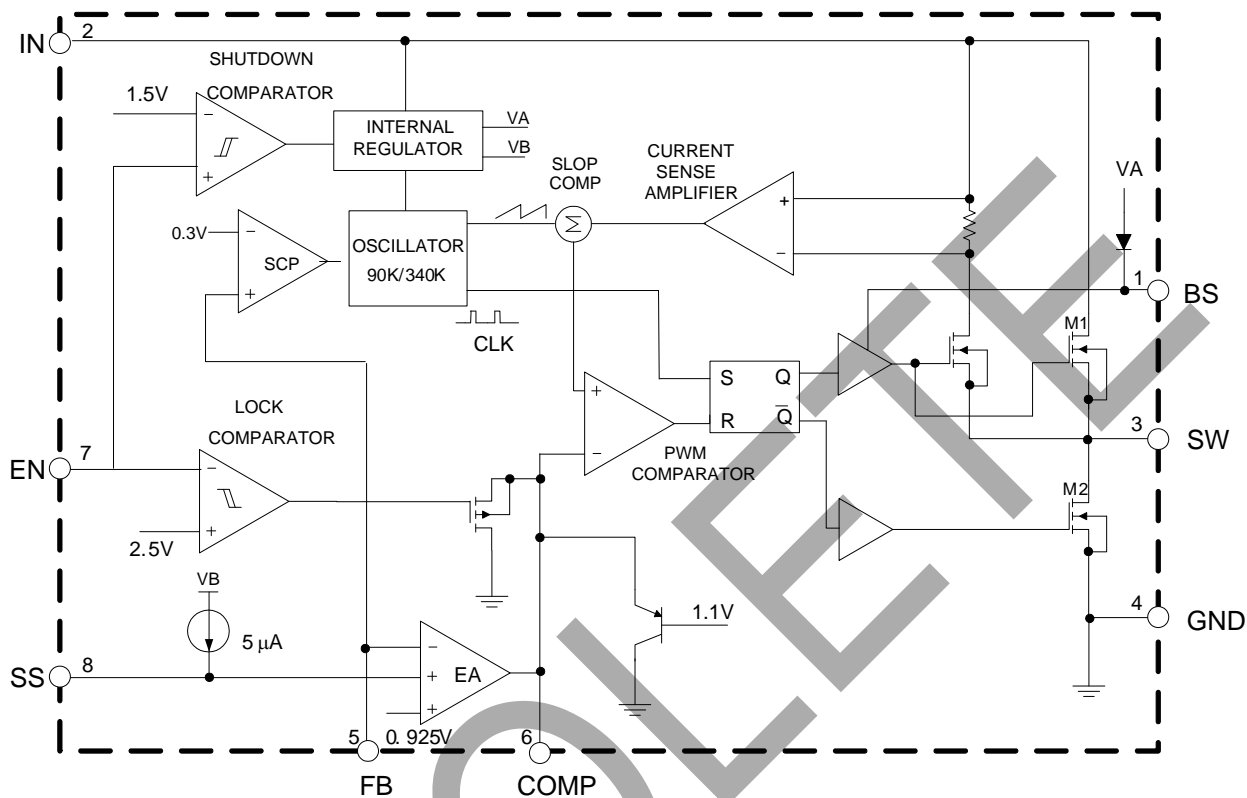
## Typical Applications Circuit



## Pin Descriptions

| Pin Number | Pin Name | Function   |
|------------|----------|--|
| 1          | BS       | Bootstrap pin. A bootstrap capacitor is connected between the BS pin and SW pin. The voltage across the bootstrap capacitor drives the internal high-side power MOSFET   |
| 2          | IN       | Supply power input pin. A capacitor should be connected between the IN pin and GND pin to keep the input voltage constant  |
| 3          | SW       | Power switch output pin. This pin is connected to the inductor and bootstrap capacitor   |
| 4          | GND      | Ground pin   |
| 5          | FB       | Feedback pin. This pin is connected to an external resistor divider to program the system output voltage. When the FB pin voltage exceeds 1.1V, the over voltage protection is triggered. When the FB pin voltage is below 0.3V, the oscillator frequency is lowered to realize short circuit protection |
| 6          | COMP     | Compensation pin. This pin is the output of the transconductance error amplifier and the input to the current comparator. It is used to compensate the control loop. Connect a series RC network from this pin to GND. In some cases, an additional capacitor from this pin to GND pin is required       |
| 7          | EN       | Control input pin. EN is a digital input that turns the regulator on or off. Drive EN high/low to turn on/off the regulator. Pull up with 100kΩ resistor for automatic startup   |
| 8          | SS       | Soft-start control input pin. SS controls the soft-start period. Connect a capacitor from SS to GND to set the soft-start period. A 0.1µF capacitor sets the soft-start period to 15ms. To disable the soft-start feature, leave SS unconnected  |
| —          | EP       | Exposed pad. It should be connected to GND in PCB layout   |

# Functional Block Diagram



OBSOLETE - PART DISCONTINUED

## Absolute Maximum Ratings (Note 1)

| Symbol        | Parameter                           | Value              | Unit |
|---------------|-------------------------------------|--------------------|------|
| $V_{IN}$      | IN Pin Voltage                      | -0.3 to 20         | V    |
| $V_{EN}$      | EN Pin Voltage                      | -0.3 to $V_{IN}$   | V    |
| $V_{SW}$      | SW Pin Voltage                      | 21                 | V    |
| $V_{BS}$      | BS Pin Voltage                      | -0.3 to $V_{SW}+6$ | V    |
| $V_{FB}$      | FB Pin Voltage                      | -0.3 to 6          | V    |
| $V_{COMP}$    | COMP Pin Voltage                    | -0.3 to 6          | V    |
| $V_{SS}$      | SS Pin Voltage                      | -0.3 to 6          | V    |
| $\theta_{JA}$ | Thermal Resistance                  | 60                 | °C/W |
| $T_J$         | Operating Junction Temperature      | +150               | °C   |
| $T_{STG}$     | Storage Temperature                 | -65 to +150        | °C   |
| $T_{LEAD}$    | Lead Temperature (Soldering, 10sec) | +260               | °C   |
| $V_{HBM}$     | ESD (Human Body Model)              | 2000               | V    |
| $V_{MM}$      | ESD (Machine Model)                 | 200                | V    |

Note 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

## Recommended Operating Conditions

| Symbol   | Parameter                     | Min | Max | Unit |
|----------|-------------------------------|-----|-----|------|
| $V_{IN}$ | Input Voltage                 | 4.5 | 18  | V    |
| $T_A$    | Operating Ambient Temperature | -40 | +85 | °C   |

**Electrical Characteristics** ( $T_A=+25^{\circ}\text{C}$ ,  $V_{IN}=V_{EN}=12\text{V}$ ,  $V_{OUT}=3.3\text{V}$ , unless otherwise specified.)

| Symbol                            | Parameter   | Conditions                                      | Min   | Typ   | Max   | Unit          |
|-----------------------------------|---|---|-------|-------|-------|---------------|
| <b>SUPPLY VOLTAGE (IN PIN)</b>    |   |   |       |       |       |               |
| $V_{IN}$                          | Input Voltage                                     | –   | 4.5   | –     | 18    | V             |
| $I_Q$                             | Quiescent Current                                 | $V_{FB}=1\text{V}$ , $V_{EN}=3\text{V}$         | –     | 1.2   | 1.4   | mA            |
| $I_{SHDN}$                        | Shutdown Supply Current                           | $V_{EN}=0\text{V}$                              | –     | 0.1   | 10    | $\mu\text{A}$ |
| <b>UNDER VOLTAGE LOCKOUT</b>      |   |   |       |       |       |               |
| $V_{UVLO}$                        | Input UVLO Threshold                              | $V_{IN}$ Rising                                 | 3.65  | 4.00  | 4.25  | V             |
| $V_{HYS}$                         | Input UVLO Hysteresis                             | –   | –     | 200   | –     | mV            |
| <b>ENABLE (EN PIN)</b>            |   |   |       |       |       |               |
| –                                 | EN Shutdown Threshold Voltage                     | –   | 1.1   | 1.5   | 2     | V             |
| –                                 | EN Shutdown Threshold Voltage Hysteresis (Note 3) | –   | –     | 350   | –     | mV            |
| –                                 | EN Lockout Threshold Voltage                      | –   | 2.2   | 2.5   | 2.7   | V             |
| –                                 | EN Lockout Hysteresis                             | –   | –     | 210   | –     | mV            |
| <b>VOLTAGE REFERENCE (FB PIN)</b> |   |   |       |       |       |               |
| $V_{FB}$                          | Feedback Voltage                                  | –   | 0.907 | 0.925 | 0.943 | V             |
| $V_{FBOV}$                        | Feedback Over Voltage Threshold                   | –   | –     | 1.1   | –     | V             |
| $I_{FB}$                          | Feedback Bias Current                             | $V_{FB}=1\text{V}$                              | -0.1  | –     | 0.1   | $\mu\text{A}$ |
| <b>MOSFET</b>                     |   |   |       |       |       |               |
| $R_{DS(on)H}$                     | High-Side Switch On-resistance (Note 2)           | $I_{SW}=0.2\text{A}/0.7\text{A}$                | –     | 100   | –     | m $\Omega$    |
| $R_{DS(on)L}$                     | Low-Side Switch On-resistance (Note 2)            | $I_{SW}=-0.2\text{A}/-0.7\text{A}$              | –     | 100   | –     | m $\Omega$    |
| <b>CURRENT LIMIT</b>              |   |   |       |       |       |               |
| $I_{LEAKH}$                       | High-Side Switch Leakage Current                  | $V_{IN}=18\text{V}$ , $V_{EN}=V_{SW}=0\text{V}$ | –     | 0.1   | 10    | $\mu\text{A}$ |
| $I_{LIMH}$                        | High-Side Switch Current Limit                    | –   | 4.3   | 5.6   | –     | A             |
| $I_{LIML}$                        | Low-Side Switch Current Limit                     | Drain to Source                                 | –     | 0     | –     | mA            |
| <b>SWITCHING REGULATOR</b>        |   |   |       |       |       |               |
| $f_{OSC1}$                        | Oscillator Frequency                              | –   | 280   | 340   | 400   | kHz           |
| $f_{OSC2}$                        | Short Circuit Oscillator Frequency                | –   | –     | 90    | –     | kHz           |
| $D_{MAX}$                         | Max. Duty Cycle                                   | $V_{FB}=0.85\text{V}$                           | –     | 90    | –     | %             |
| $D_{MIN}$                         | Min. Duty Cycle                                   | $V_{FB}=1\text{V}$                              | –     | –     | 0     | %             |

**Electrical Characteristics** (Cont.  $T_A=+25^{\circ}\text{C}$ ,  $V_{IN}=V_{EN}=12\text{V}$ ,  $V_{OUT}=3.3\text{V}$ , unless otherwise specified.)

| Symbol                     | Parameter                              | Conditions          | Min | Typ  | Max | Unit               |
|----------------------------|--|---------------------|-----|------|-----|--------------------|
| <b>ERROR AMPLIFIER</b>     |  |                     |     |      |     |                    |
| $A_{EA}$                   | Error Amplifier Voltage Gain (Note 3)  | –                   | –   | 400  | –   | V/V                |
| $G_{EA}$                   | Error Amplifier Transconductance       | –                   | –   | 800  | –   | $\mu\text{A/V}$    |
| $G_{CS}$                   | COMP to Current Sense Transconductance | –                   | –   | 5.2  | –   | A/V                |
| <b>THERMAL SHUTDOWN</b>    |  |                     |     |      |     |                    |
| $T_{OTSD}$                 | Thermal Shutdown (Note 3)              | –                   | –   | +160 | –   | $^{\circ}\text{C}$ |
| $T_{HYS}$                  | Thermal Shutdown Hysteresis (Note 3)   | –                   | –   | +20  | –   | $^{\circ}\text{C}$ |
| <b>SOFT START (SS PIN)</b> |  |                     |     |      |     |                    |
| $t_{SS}$                   | Soft-Start Time (Note 3)               | $C5=0.1\mu\text{F}$ | –   | 15   | –   | ms                 |
| –                          | Soft-Start Current                     | –                   | –   | 5    | –   | $\mu\text{A}$      |

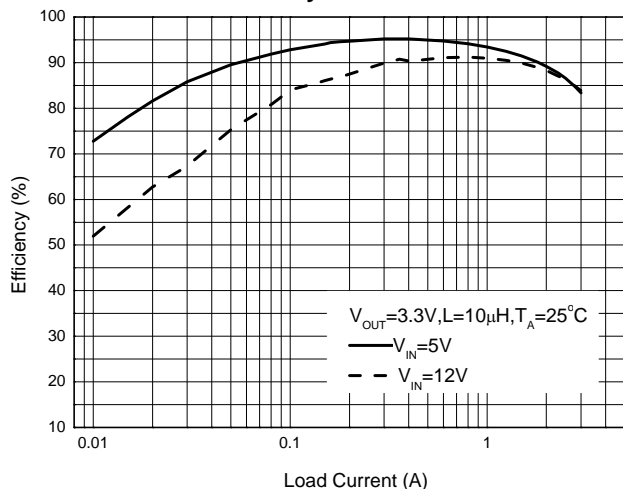
Notes: 2.  $R_{DS(on)} = \frac{V_{SW1} - V_{SW2}}{I_{SW1} - I_{SW2}}$ .

3. Not tested, guaranteed by design.

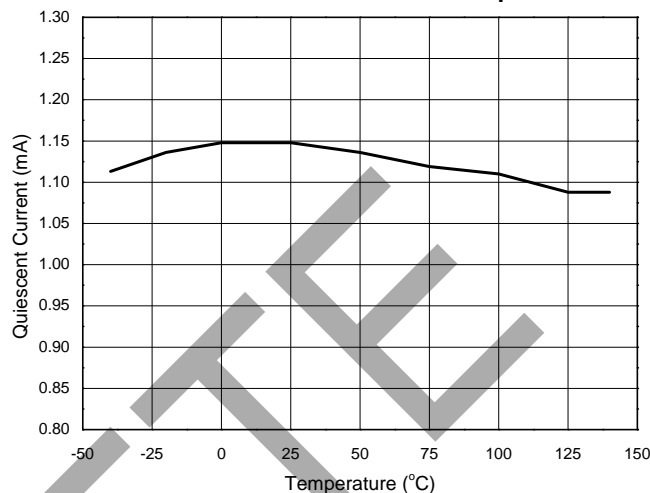
OBSOLETE – PART DISCONTINUED

**Performance Characteristics** ( $T_A=+25^{\circ}\text{C}$ ,  $V_{IN}=12\text{V}$ ,  $V_{OUT}=3.3\text{V}$ , unless otherwise noted.)

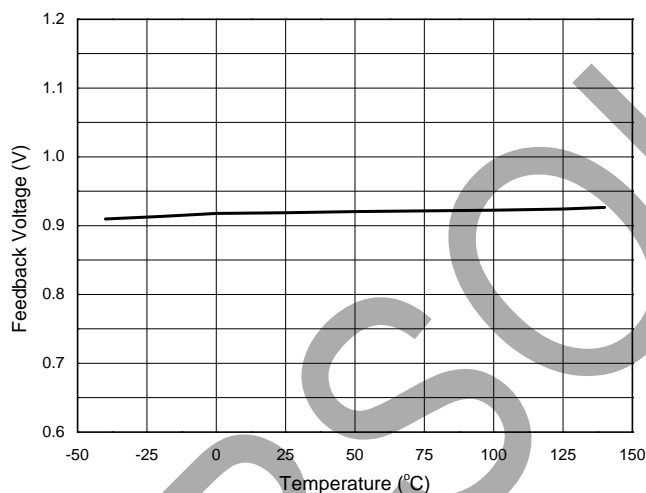
**Efficiency vs. Load Current**



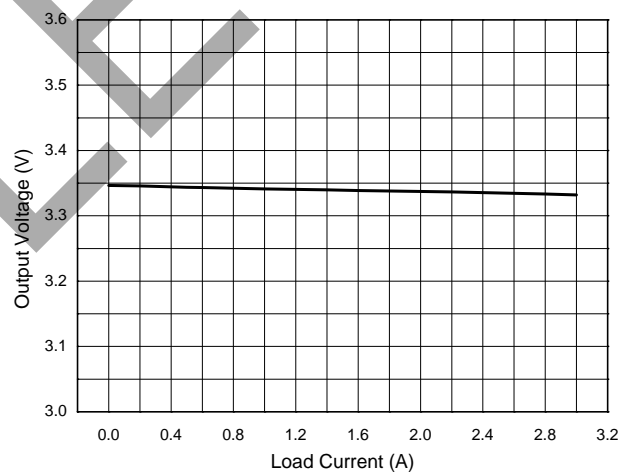
**Quiescent Current vs. Temperature**



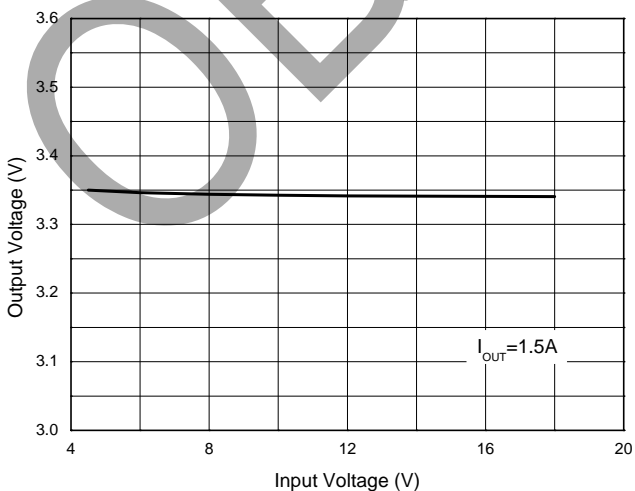
**Feedback Voltage vs. Temperature**



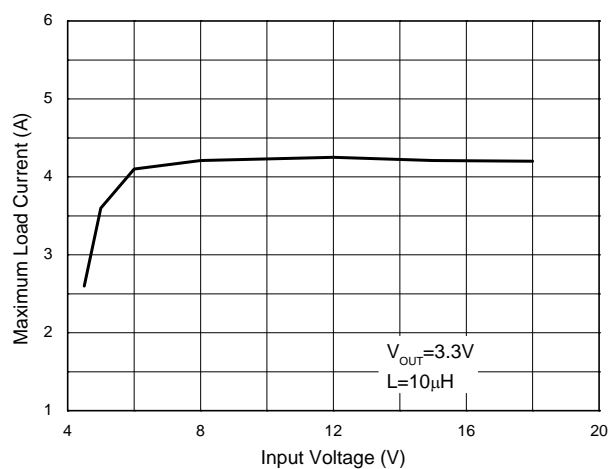
**Output Voltage vs. Load Current**



**Output Voltage vs. Input Voltage**

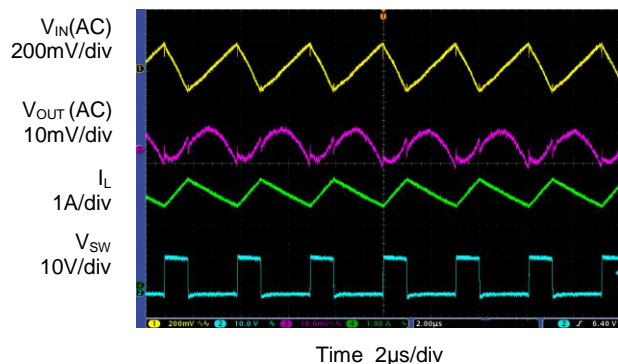


**Maximum Load Current vs. Input Voltage**

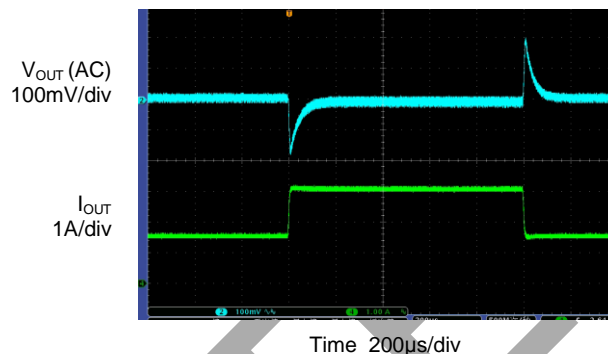


**Performance Characteristics** (Cont.  $T_A=+25^{\circ}\text{C}$ ,  $V_{\text{IN}}=12\text{V}$ ,  $V_{\text{OUT}}=3.3\text{V}$ , unless otherwise noted.)

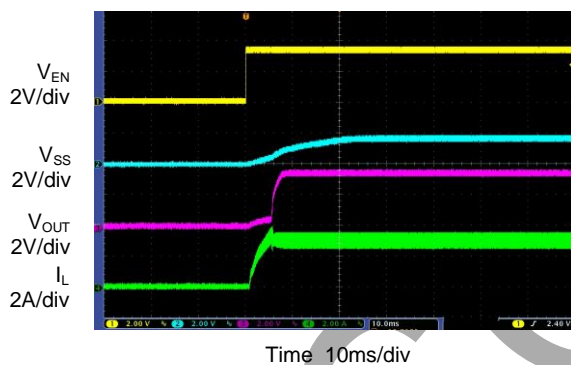
**Output Ripple ( $I_{\text{OUT}}=3\text{A}$ )**



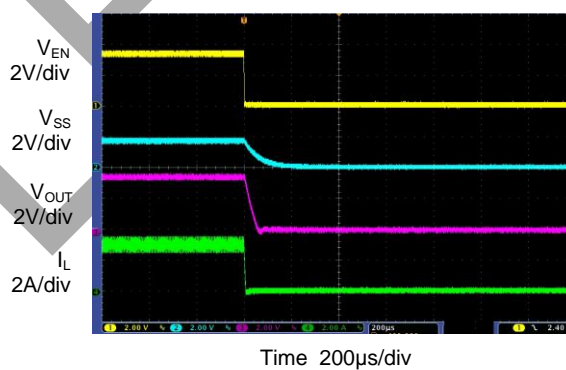
**Load Transient ( $I_{\text{OUT}}=1.5$  to  $3\text{A}$ )**



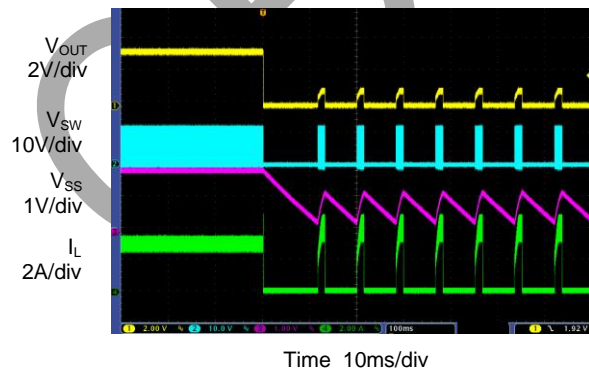
**Enable Turn-on Characteristic**  
( $V_{\text{IN}}=12\text{V}$ ,  $V_{\text{EN}}=3.3\text{V}$ ,  $V_{\text{OUT}}=3.3\text{V}$ ,  $I_{\text{OUT}}=3\text{A}$ )



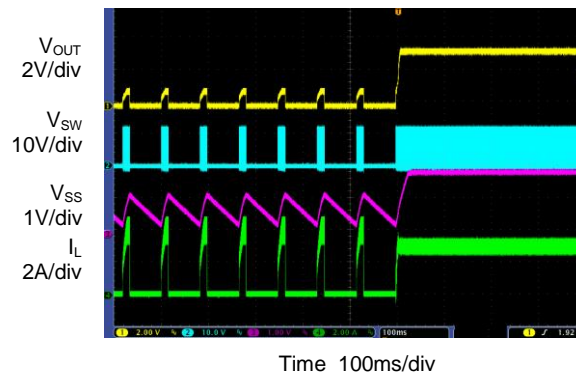
**Enable Turn-off Characteristic**  
( $V_{\text{IN}}=12\text{V}$ ,  $V_{\text{EN}}=3.3\text{V}$ ,  $V_{\text{OUT}}=3.3\text{V}$ ,  $I_{\text{OUT}}=3\text{A}$ )



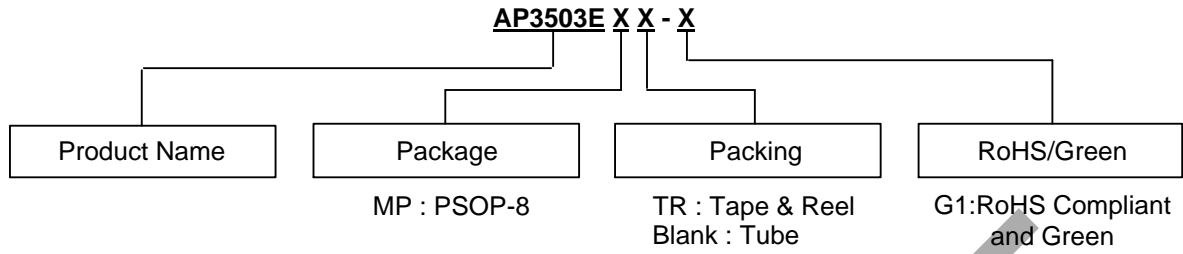
**Short Circuit Protection ( $I_{\text{OUT}}=3\text{A}$ )**



**Short Circuit Recovery ( $I_{\text{OUT}}=3\text{A}$ )**



## Ordering Information



| Package | Temperature Range | Part Number    | Marking ID | Packing     |
|---------|-------------------|----------------|------------|-------------|
| PSOP-8  | -40 to +85°C      | AP3503EMP-G1   | 3503EMP-G1 | Tube        |
|         |                   | AP3503EMPTR-G1 | 3503EMP-G1 | Tape & Reel |

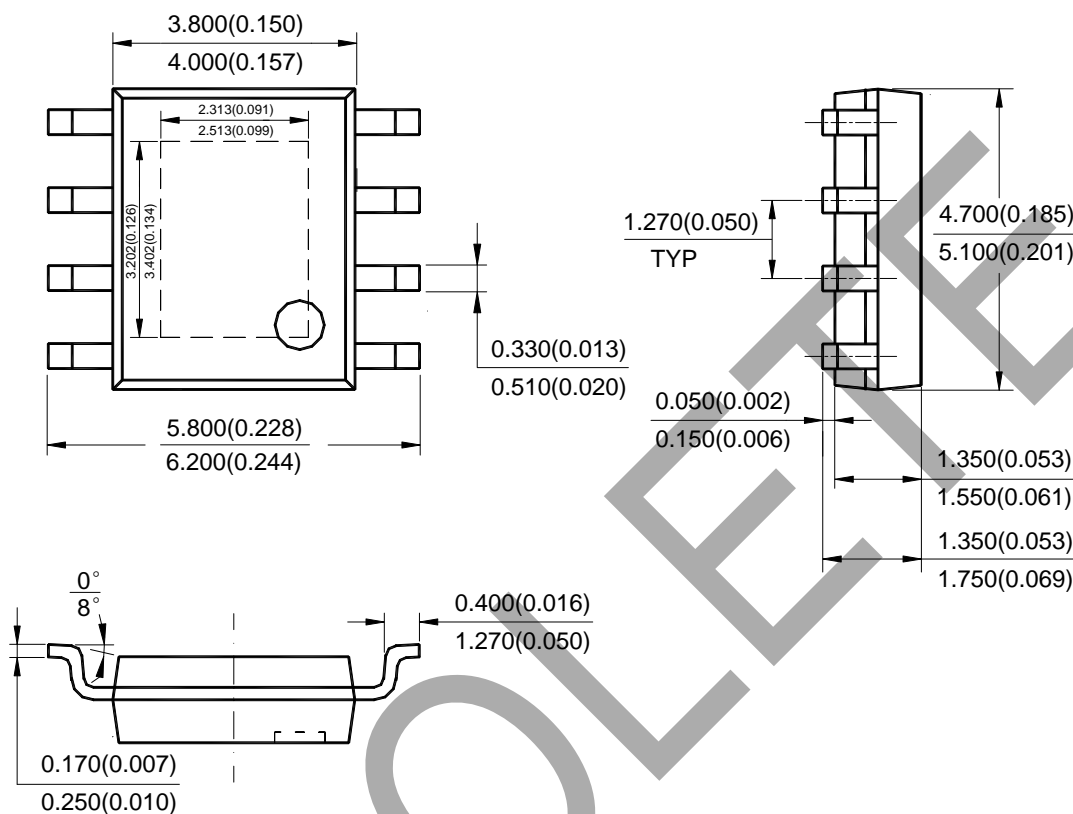
OBSOLETE

OBSOLETE - PART DISCONTINUED



**Package Outline Dimensions** (All dimensions in mm(inch).)

(1) Package Type: PSOP-8



Note: Eject hole, oriented hole and mold mark is optional.

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